

February 1994 Revised February 2004

#### 74LCX244

# Low Voltage Buffer/Line Driver with 5V Tolerant Inputs and Outputs

#### **General Description**

The LCX244 contains eight non-inverting buffers with 3-STATE outputs. The device may be employed as a memory address driver, clock driver and bus-oriented transmitter/receiver. The LCX244 is designed for low voltage (2.5V or 3.3V)  $\rm V_{CC}$  applications with capability of interfacing to a 5V signal environment.

The LCX244 is fabricated with an advanced CMOS technology to achieve high speed operation while maintaining CMOS low power dissipation.

#### **Features**

- 5V tolerant inputs and outputs
- 2.3V to 3.6V V<sub>CC</sub> specifications provided
- 6.5 ns  $t_{PD}$  max ( $V_{CC} = 3.3V$ ), 10  $\mu$ A  $I_{CC}$  max
- Power down high impedance inputs and outputs
- Supports live insertion/withdrawal (Note 1)
- $\pm$ 24 mA output drive ( $V_{CC} = 3.0V$ )
- Implements patented noise/EMI reduction circuitry
- Latch-up performance exceeds 500 mA
- ESD performance: Human body model > 2000V Machine model > 200V
- Leadless DQFN package

**Note 1:** To ensure the high-impedance state during power up or down,  $\overline{\text{OE}}$  should be tied to  $V_{CC}$  through a pull-up resistor: the minimum value or the resistor is determined by the current-sourcing capability of the driver.

# **Ordering Code:**

Order Number	Package Number	Package Description
74LCX244WM (Note 2)	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide
74LCX244SJ (Note 2)	M20D	20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74LCX244BQX (Note 3)	MLP020B	20-Terminal Depopulated Quad Very-Thin Flat Pack No Leads (DQFN), JEDEC MO-241, 2.5 x 4.5mm
74LCX244MSA (Note 2)	MSA20	20-Lead Shrink Small Outline Package (SSOP), JEDEC MO-150, 5.3mm Wide
74LCX244MTC (Note 2)	MTC20	20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

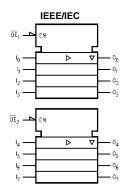
Note 2: Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Note 3: DQFN package available in Tape and Reel only.

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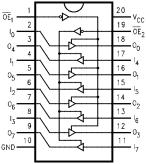
DS500107

# **Logic Symbol**

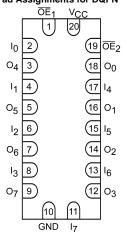


# **Connection Diagrams**

Pin Assignments for SOIC, SOP, SSOP, and TSSOP



#### Pad Assignments for DQFN



(Top Through View)

# **Pin Descriptions**

Pin Names	Description
$\overline{OE}_1$ , $\overline{OE}_2$	3-STATE Output Enable Inputs
$I_0 - I_7$	Inputs
$O_0 - O_7$	Outputs

## **Truth Tables**

Inputs		Outputs
OE <sub>1</sub>	In	(Pins 12, 14, 16, 18)
L	L	L
L	Н	Н
Η	Х	Z

Inputs		Outputs
OE <sub>2</sub>	In	(Pins 3, 5, 7, 9)
٦	L	L
L	Н	Н
Н	Х	Z

H = HIGH Voltage Level L = LOW Voltage Level

X = Immaterial Z = High Impedance

Symbol	Parameter	Value	Conditions	Units
V <sub>CC</sub>	Supply Voltage	-0.5 to +7.0		V
٧ı	DC Input Voltage	-0.5 to +7.0		V
v <sub>o</sub>	DC Output Voltage	−0.5 to +7.0	Output in 3-STATE	V
		$-0.5$ to $V_{CC} + 0.5$	Output in HIGH or LOW State (Note 5)	
l <sub>IK</sub>	DC Input Diode Current	-50	V <sub>I</sub> < GND	mA
ОК	DC Output Diode Current	-50	V <sub>O</sub> < GND	mA
		+50	$V_O > V_{CC}$	IIIA
О	DC Output Source/Sink Current	±50		mA
lcc	DC Supply Current per Supply Pin	±100		mA
GND	DC Ground Current per Ground Pin	±100		mA
T <sub>STG</sub>	Storage Temperature	-65 to +150		°C

# **Recommended Operating Conditions** (Note 6)

Symbol	Parameter		Min	Max	Units
V <sub>CC</sub>	Supply Voltage	Operating	2.0	3.6	V
		Data Retention	1.5	3.6	V
VI	Input Voltage		0	5.5	V
Vo	Output Voltage	HIGH or LOW State	0	V <sub>CC</sub>	V
		3-STATE	0	5.5	V
I <sub>OH</sub> /I <sub>OL</sub>	Output Current	$V_{CC} = 3.0V \text{ to } 3.6V$		±24	
		$V_{CC} = 2.7V \text{ to } 3.0V$		±12	mA
		$V_{CC} = 2.3V \text{ to } 2.7V$		±8	
T <sub>A</sub>	Free-Air Operating Temperature		-40	85	°C
Δt/ΔV	Input Edge Rate, $V_{IN} = 0.8V$ to 2.0V, $V_{CC} = 3.0V$	1	0	10	ns/V

Note 4: The Absolute Maximum Ratings are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the Absolute Maximum Ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 5:  $I_O$  Absolute Maximum Rating must be observed.

Note 6: Unused inputs or I/Os must be held HIGH or LOW. They may not float.

# **DC Electrical Characteristics**

Symbol	Parameter	Conditions	V <sub>CC</sub>	$T_A = -40^{\circ}C$ to $+85^{\circ}C$		Units
Syllibol		Conditions	(V)	Min	Max	Units
V <sub>IH</sub>	HIGH Level Input Voltage		2.3 to 2.7	1.7		V
			2.7 to 3.6	2.0		· ·
V <sub>IL</sub>	LOW Level Input Voltage		2.3 to 2.7		0.7	V
			2.7 to 3.6		0.8	· ·
V <sub>OH</sub>	HIGH Level Output Voltage	$I_{OH} = -100 \mu A$	2.3 to 3.6	V <sub>CC</sub> - 0.2		
		$I_{OH} = -8 \text{ mA}$	2.3	1.8		
		$I_{OH} = -12 \text{ mA}$	2.7	2.2		٧
		$I_{OH} = -18 \text{ mA}$	3.0	2.4		
		$I_{OH} = -24 \text{ mA}$	3.0	2.2		
V <sub>OL</sub>	LOW Level Output Voltage	I <sub>OL</sub> = 100 μA	2.3 to 3.6		0.2	
		$I_{OL} = 8 \text{ mA}$	2.3		0.6	
		I <sub>OL</sub> = 12 mA	2.7		0.4	V
		I <sub>OL</sub> = 16 mA	3.0		0.4	
		$I_{OL} = 24 \text{ mA}$	3.0		0.55	
l <sub>l</sub>	Input Leakage Current	$0 \le V_1 \le 5.5V$	2.3 to 3.6		±5.0	μΑ
l <sub>oz</sub>	3-STATE Output Leakage	$0 \le V_O \le 5.5V$	2.3 to 3.6		±5.0	μА
		$V_I = V_{IH}$ or $V_{IL}$	2.3 10 3.0		±5.0	μΑ
l <sub>OFF</sub>	Power-Off Leakage Current	$V_1$ or $V_0 = 5.5V$	0		10	μΑ

# DC Electrical Characteristics (Continued)

Symbol	Parameter	Conditions	V <sub>CC</sub>	T <sub>A</sub> = -40°0	C to +85°C	Units
Cymbol	i arameter	Conditions	(V)	Min	Max	Onics
I <sub>CC</sub>	Quiescent Supply Current	$V_I = V_{CC}$ or GND	2.3 – 3.6		10	μА
		3.6V ≤ V <sub>I</sub> , V <sub>O</sub> ≤ 5.5V (Note 7)	2.3 – 3.6		±10	μΛ
Δl <sub>CC</sub>	Increase in I <sub>CC</sub> per Input	$V_{IH} = V_{CC} - 0.6V$	2.3 – 3.6		500	μΑ

Note 7: Outputs disabled or 3-STATE only.

## **AC Electrical Characteristics**

		$T_A = -40$ °C to $+85$ °C, $R_L = 500\Omega$						
Symbol	Parameter	V <sub>CC</sub> = 3.3	3V ± 0.3V	V <sub>CC</sub> =	= 2.7V	V <sub>CC</sub> = 2	.5V ± 0.2	Units
Syllibol	Farameter	C <sub>L</sub> =	50 pF	C <sub>L</sub> =	50 pF	C <sub>L</sub> =	30 pF	Units
		Min	Max	Min	Max	Min	Max	
t <sub>PHL</sub>	Propagation Delay	1.5	6.5	1.5	7.5	1.5	7.8	
t <sub>PLH</sub>	Data to Output	1.5	6.5	1.5	7.5	1.5	7.8	ns
t <sub>PZL</sub>	Output Enable Time	1.5	8.0	1.5	9.0	1.5	10.0	ns
t <sub>PZH</sub>		1.5	8.0	1.5	9.0	1.5	10.0	115
t <sub>PLZ</sub>	Output Disable Time	1.5	7.0	1.5	8.0	1.5	8.4	ns
t <sub>PHZ</sub>		1.5	7.0	1.5	8.0	1.5	8.4	115
toshl	Output to Output Skew		1.0					ns
toslh	(Note 8)		1.0					115

Note 8: Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t<sub>OSHL</sub>) or LOW-to-HIGH (t<sub>OSLH</sub>).

# **Dynamic Switching Characteristics**

Symbol	Parameter	Conditions	V <sub>CC</sub>	$T_A = 25^{\circ}C$	Units
Symbol	r al allietei	Conditions	(V)	Typical	Oillis
V <sub>OLP</sub>	Quiet Output Dynamic Peak V <sub>OL</sub>	C <sub>L</sub> = 50 pF, V <sub>IH</sub> = 3.3V, V <sub>IL</sub> = 0V	3.3	0.8	V
		$C_L = 30 \text{ pF}, V_{IH} = 2.5 \text{V}, V_{IL} = 0 \text{V}$	2.5	0.6	V
V <sub>OLV</sub>	Quiet Output Dynamic Valley V <sub>OL</sub>	$C_L = 50 \text{ pF}, V_{IH} = 3.3 \text{V}, V_{IL} = 0 \text{V}$	3.3	-0.8	V
		$C_L = 30 \text{ pF}, V_{IH} = 2.5 \text{V}, V_{IL} = 0 \text{V}$	2.5	-0.6	V

# Capacitance

Symbol	Parameter	Conditions	Typical	Units
C <sub>IN</sub>	Input Capacitance	$V_{CC}$ = Open, $V_I$ = 0V or $V_{CC}$	7.0	pF
C <sub>OUT</sub>	Output Capacitance	$V_{CC} = 3.3V$ , $V_I = 0V$ or $V_{CC}$	8.0	pF
C <sub>PD</sub>	Power Dissipation Capacitance	$V_{CC} = 3.3V$ , $V_{I} = 0V$ or $V_{CC}$ , $f = 10$ MHz	25.0	pF

## AC LOADING and WAVEFORMS Generic for LCX Family

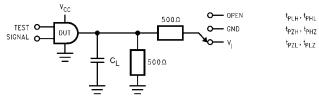
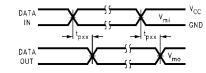
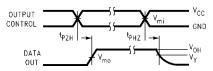


FIGURE 1. AC Test Circuit ( $C_L$  includes probe and jig capacitance)

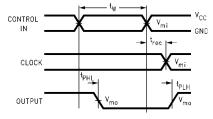
Test	Switch
t <sub>PLH</sub> , t <sub>PHL</sub>	Open
$t_{PZL}, t_{PLZ}$	6V at $V_{CC} = 3.3V \pm 0.3V$
	$V_{CC}$ x 2 at $V_{CC}$ = 2.5V $\pm$ 0.2V
t <sub>PZH</sub> , t <sub>PHZ</sub>	GND



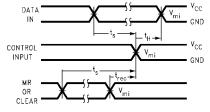
Waveform for Inverting and Non-Inverting Functions



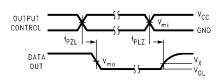
3-STATE Output High Enable and Disable Times for Logic



Propagation Delay. Pulse Width and  $t_{\rm rec}$  Waveforms



Setup Time, Hold Time and Recovery Time for Logic



3-STATE Output Low Enable and Disable Times for Logic

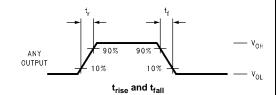
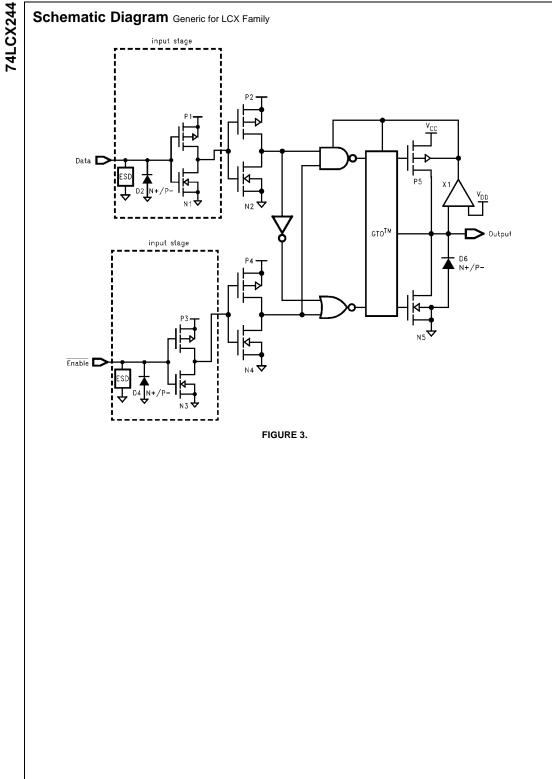


FIGURE 2. Waveforms (Input Characteristics; f = 1MHz,  $t_r = t_f = 3ns$ )

Symbol	V <sub>cc</sub>						
	$3.3V \pm 0.3V$	2.7V	2.5V ± 0.2V				
$V_{mi}$	1.5V	1.5V	V <sub>CC</sub> /2				
$V_{mo}$	1.5V	1.5V	V <sub>CC</sub> /2				
V <sub>x</sub>	V <sub>OL</sub> + 0.3V	V <sub>OL</sub> + 0.3V	V <sub>OL</sub> + 0.15V				
V <sub>y</sub>	V <sub>OH</sub> – 0.3V	V <sub>OH</sub> – 0.3V	V <sub>OH</sub> – 0.15V				



Sealed

Sealed

#### **Tape and Reel Specification** Tape Format for DQFN Package Таре Number Cavity Cover Tape Designator Section Cavities Status Status Leader (Start End) 125 (typ) Empty Sealed BQX

3000

75 (typ)

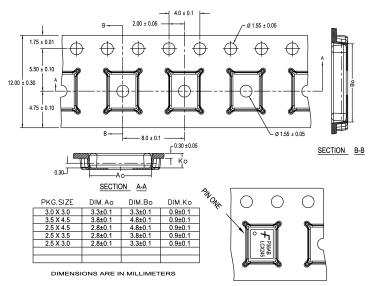
Filled

Empty

TAPE DIMENSIONS inches (millimeters)

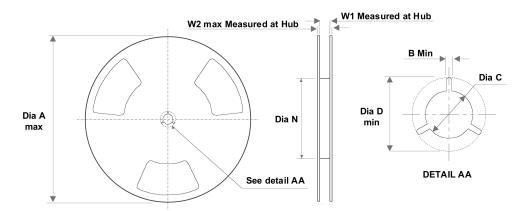
Carrier

Trailer (Hub End)

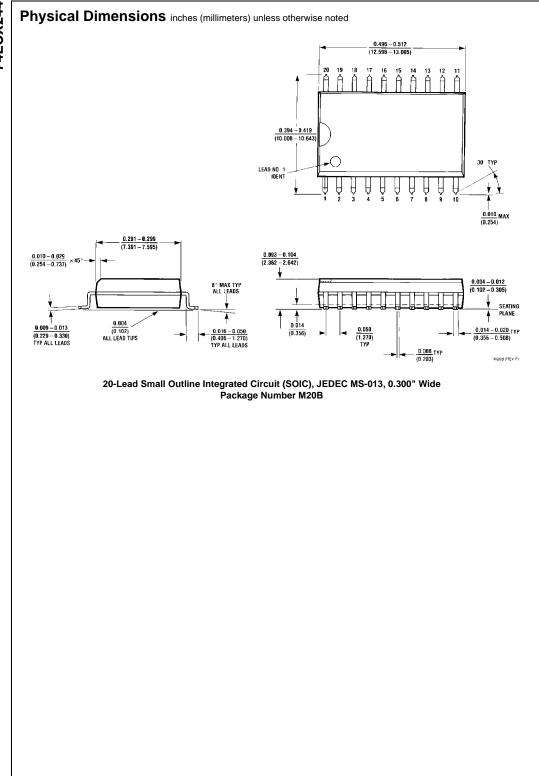


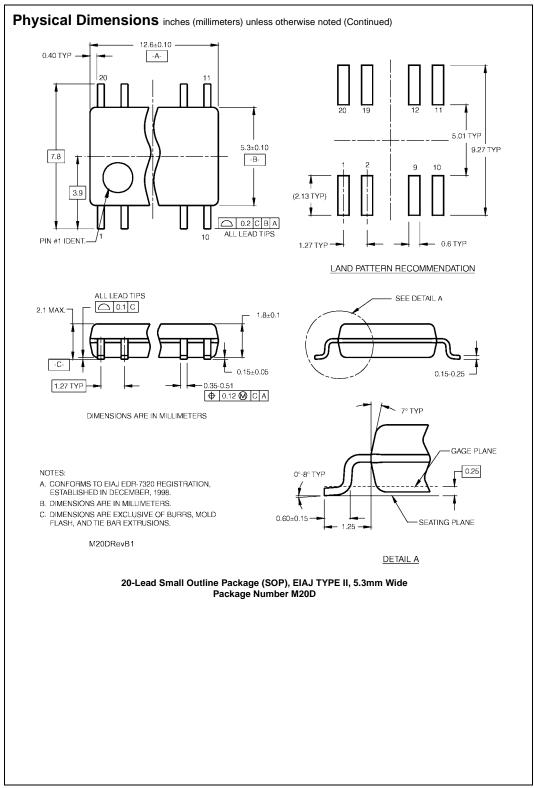
FSC MLP/DQFN CARRIER TAPE SPECIFICATIONS

#### **REEL DIMENSIONS** inches (millimeters)

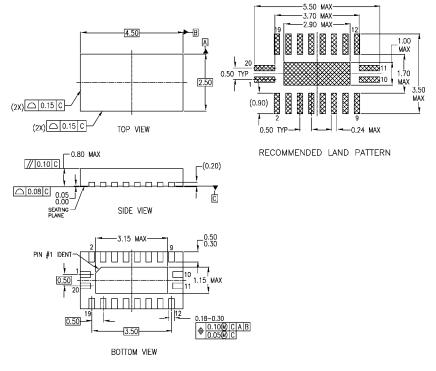


Tape Size	Α	В	С	D	N	W1	W2
12 mm	13.0	0.059	0.512	0.795	2.165	0.488	0.724
	(330.0)	(1.50)	(13.00)	(20.20)	(55.00)	(12.4)	(18.4)





# Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

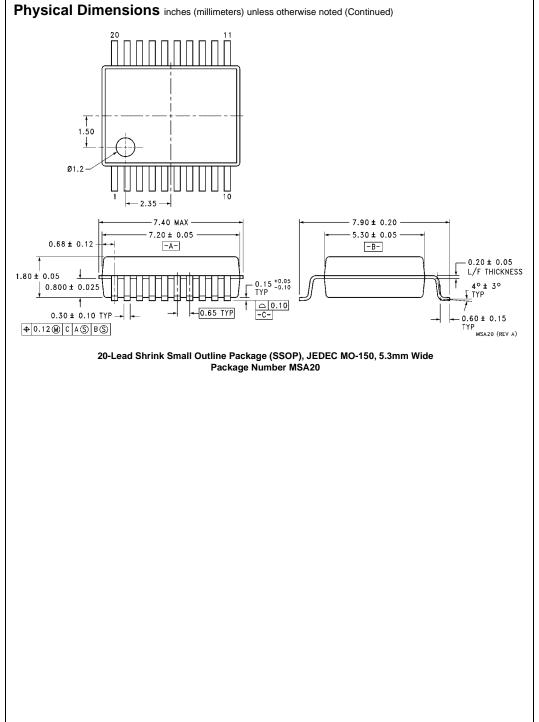


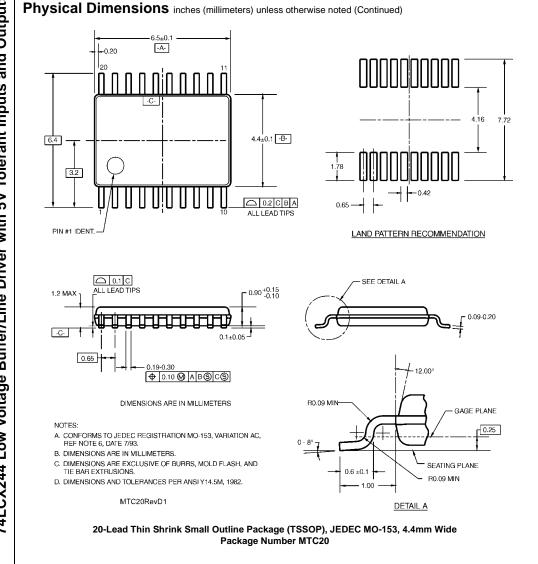
#### NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-241, VARIATION AC
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994

#### MLP020BrevA

20-Terminal Depopulated Quad Very-Thin Flat Pack No Leads (DQFN), JEDEC MO-241, 2.5 x 4.5mm Package Number MLP020B





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